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Installation

Mechanical design



MODEL NO : ET055FH06-OT

MODEL VERSION: 01

SPEC VERSION : 1.0

ISSUED DATE: 2021-03-10

- ☒ Preliminary Specification
☐ Final Product Specification

Customer : _____

Approved by	Notes

Youri Confirmation

Prepared by	Reviewed by	Approved by
John	Johnny	Wang

[illegible]

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1. General Specifications

No.	Item	Specification	Remark
1	LCD size	5.5 inch	
2	Driver element	a-Si TFT active matrix	
3	Resolution	1080(W) RGB x1920(H)	
4	Display mode	Normally Black, Transmissive	
5	Dot pitch	0.063(W) x 0.063(H)mm	
6	Active area	68.04(W) x 120.96(H) mm	
7	Module size	75.94(W) x 134.56(H) x3.285(D) mm	Note 1
9	View direction	ALL	O 'clock
10	Surface treatment	Anti-Glare	
11	Color arrangement	RGB-stripe	
12	Interface	MIPI	
13	Drive IC	HX8398	

Note 1: Refer to Mechanical drawing.

2. Pin Assignment

FPC Connector is used for the module electronics interface. The recommended model is DF40C-40DP-0.4V(51)

Pin No	Symbol	Function	Remark
1	GND	GND Ground	
2	GND	GND Ground	
3	TOUCH_RST	Touch reset (1.8V)	
4	LCD_RST	LCD reset	
5	TOUCH_INT	Touch INT (1.8V)	
6	LCD_TE	LCD_TE LCD Tearing effect output	
7	I2C4_SDA_TP	Touch I2C SDA (1.8V)	
8	LCD_ID	LCD_ID signal	
9	I2C4_SCL_TP	Touch I2C SCL (1.8V)	
10	GND	Ground	
11	VCC_TP	Touch power(+2.8V)	
12	MIPI_TXO_D0N	MIPI data lane 0 negative end input/output pin	
13	GND	Ground	
14	MIPI_TXO_D0P	MIPI data lane 0 positive end input/output pin	
15	VCC_LED+	Backlight LED+	
16	GND	Ground	
17	VCC_LED+	Backlight LED+	
18	MIPI_TXO_D1N	MIPI data lane 1 negative end input/output pin	
19	GND	Ground	
20	MIPI_TXO_D1P	MIPI data lane 1 positive end input/output pin	
21	VCC_LED_3-	Backlight LED3-	
22	GND	Ground	
23	VCC_LED_2-	Backlight LED2-	
24	MIPI_TXO_CLKN	MIPI DSI clock lane negative end input pin	
25	VCC_LED_1-	Backlight LED1-	
26	MIPI_TXO_CLKP	MIPI DSI clock lane positive end input pin	
27	GND	Ground	
28	GND	Ground	
29	7P0_PWM_OUT	PWM out for brightness of backlight	
30	MIPI_TXO_D2N	MIPI data lane 2 negative end input/output pin	

31	VCC_LCD	LCD power	
32	MIPI_TXO_D2P	MIPI data lane 2 positive end input/output pin	
33	GND	Ground	
34	GND	Ground	
35	VSP	VSP LCD power	
36	MIPI_TXO_D3N	MIPI data lane 3 negative end input/output pin	
37	VSN	VSN LCD power	
38	MIPI_TXO_D3P	MIPI data lane 3 positive end input/output pin	
39	GND	GND Ground	
40	GND	GND Ground	

Note I: input; O: output; P: Power or Ground(0V).

3. Operation Specifications

3.1. Electrical Specifications

Test condition: GND=0V, T_A=25 °C

Note1

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Power voltage	VCC_LCD	1.65	1.8	1.95	V	
	VCC_TP	2.7	2.8	3.4		
	VSP	5.44	5.54	5.64	V	
	VSN	-5.64	-5.54	-5.44		
Input logic high voltage	V _{IH}	0.7 VCC_LCD	-	VCC_LCD	V	
Input logic low voltage	V _{IL}	GND	-	0.3 VCC_LCD	V	

3.2. Current Consumption

Item	Symbol	Values			Unit	Note
		Min.	Typ.	Max.		
Current for Driver	I _{VCC_LCD}	-	27	40	mA	Note1
	I _{VSP}	-	7	15	mA	Note1
	I _{VSN}	-	7	15	mA	Note1

Note1:Max. specification: White test Pattern

3.2.1.LED drive conditions

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Voltage for LED Backlight	V_L	27.5	-	32.0		Note 1
Current for LED Backlight	I_L	60			mA	
LED life time	-	20,000	-	-	Hr	Note 2

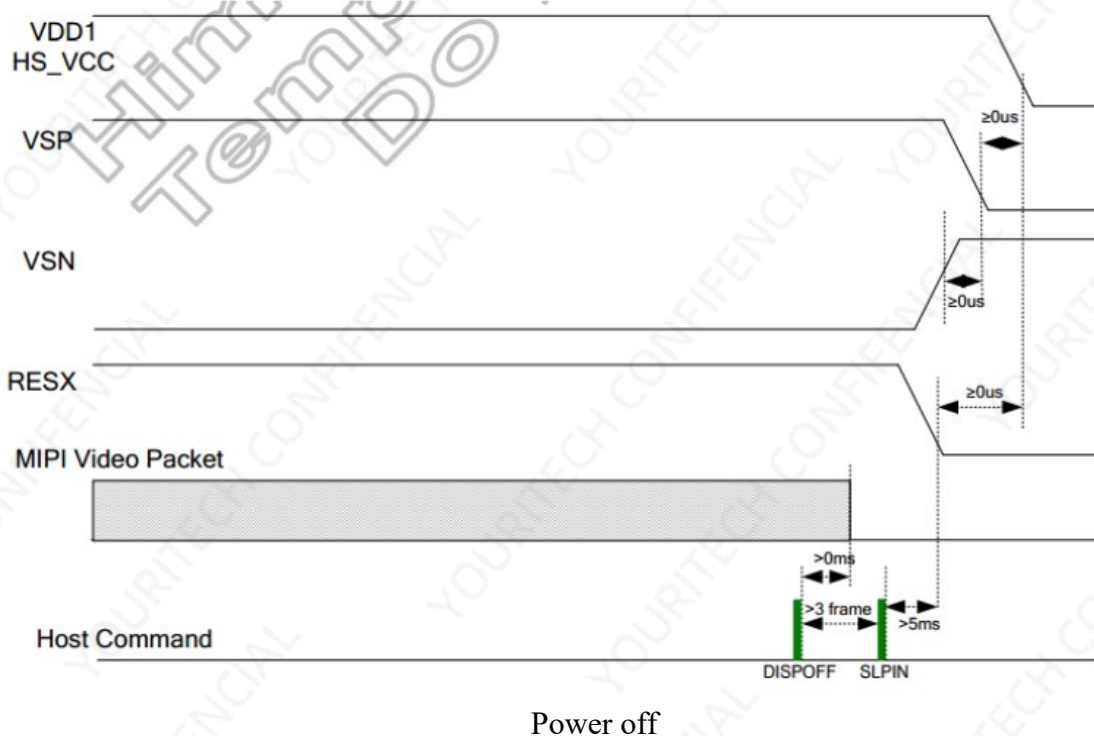
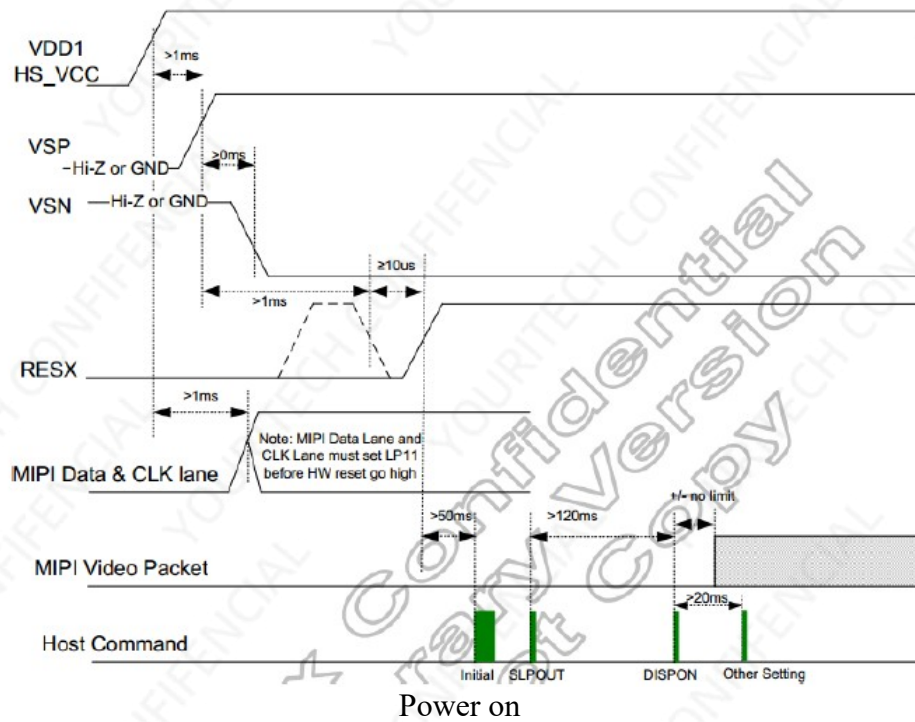
Note1: $I_L=60\text{mA}$ (Backlight circuit: 5 series connection, 3 parallel connection), the ambient temperature is 25°C .



Fig. 3-1 LED test circuit diagram

Note 2: The “LED life time” is defined as the module brightness decrease to 50% original brightness at $T_a=25^\circ\text{C}$ and 1/2 rated current . The LED lifetime could be decreased if operating I_L is larger than 60 mA.

3.3. Power Sequence



3.4. Reset input timings

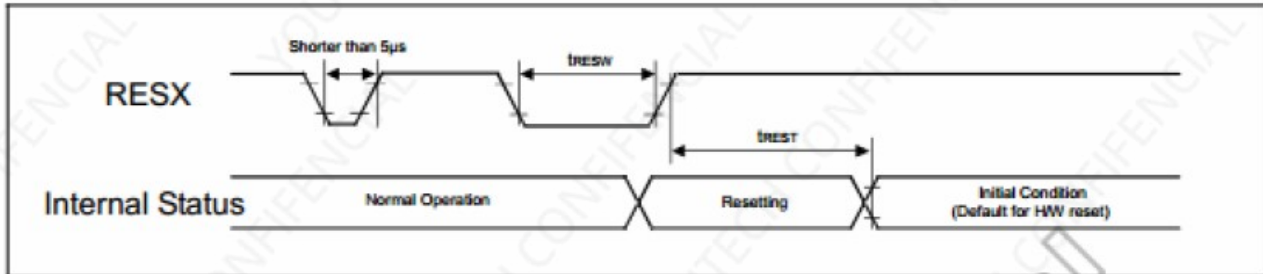


Figure 8.12: Reset input timing

Symbol	Parameter	Related pins	Spec.			Unit	Note
			Min.	Typ.	Max.		
tRESW	Reset low pulse width ⁽¹⁾	RESX	10	-	-	µs	-
tREST	Reset complete time ⁽²⁾	-	-	-	50	ms	-

Note: (1) Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below.

RESX Pulse	Action
Shorter than 5 µs	Reset Rejected
Longer than 10 µs	Reset
Between 5 µs and 10 µs	Reset Start

(2) During Reset Complete Time, OTP will be latched to internal register during this period. This loading is done every time when there is HW reset complete time (tREST) within 50ms after a rising edge of RESX.

(3) Spike Rejection also applies during a valid reset pulse as shown below:

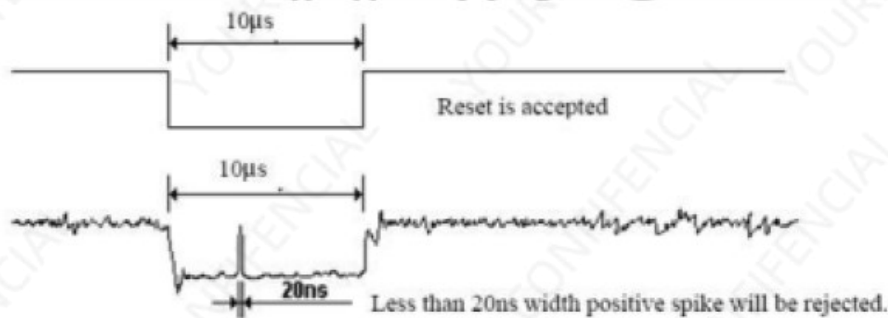
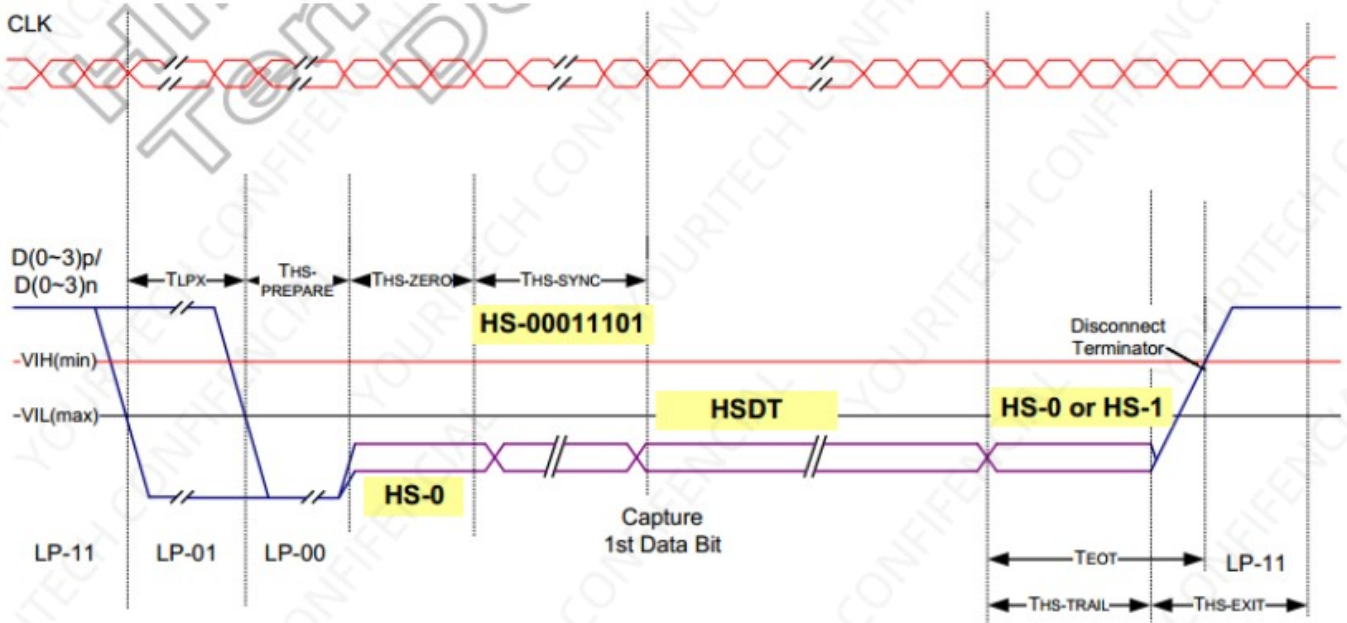


Table 8.16: Reset timing

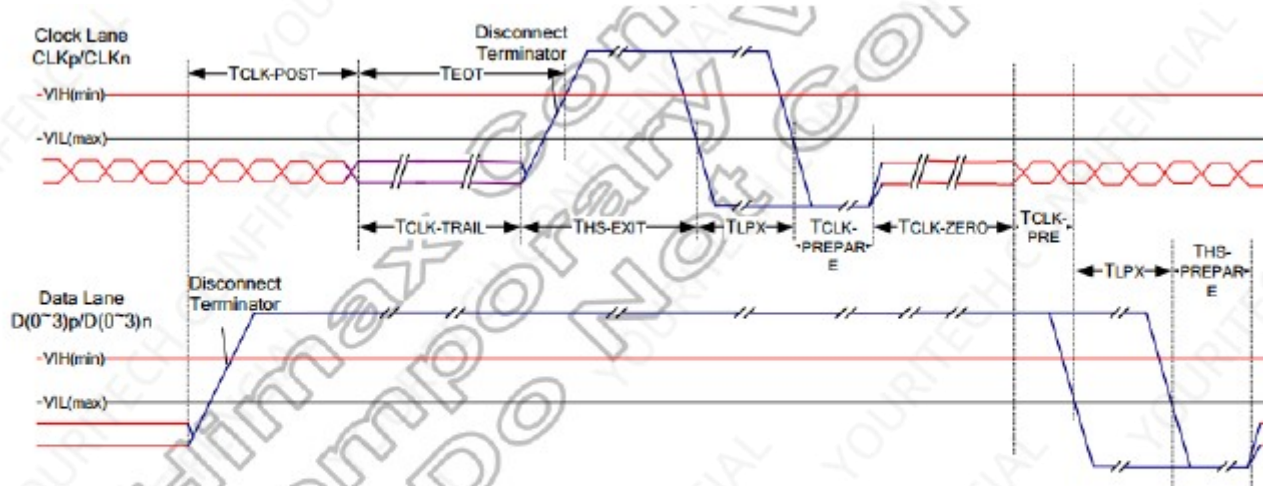
3.5. Power sequence read/write timing characteristics

3.5.1. Reset sequence



Parameter	Description	Min.	Typ.	Max.	Unit
$T_{HS-PREPARE}$	Time that the transmitter drives the Data Lane LP-00 Line state immediately before the HS-0 Line state starting the HS transmission.	$40+4*UI$	-	$85+6*UI$	ns
$T_{HS-PREPARE} + T_{HS-ZERO}$	THS-PREPARE + time that the transmitter drives the HS-0 state prior to transmitting the Sync sequence.	$145+10*UI$	-	-	ns
T_{EOT}	Transmitted time interval from the start of THS-TRAIL or TCLK-TRAIL, to the start of the LP-11 state following a HS burst.	-	-	$105ns+12*UI$	ns
$T_{HS-TRAIL}$	Time that the transmitter drives the flipped differential state after last payload data bit of a HS transmission burst.	$60ns+4*UI$	-	-	ns
$T_{HS-EXIT}$	Time that the transmitter drives LP-11 following a HS burst.	100	-	-	ns

3.5.2. Power sequence read/write timing characteristics



Parameter	Description	Min.	Typ.	Max.	Unit
$T_{CLK-POST}$	Time that the transmitter continues to send HS clock after the last associated Data Lane has transitioned to LP Mode.	$60+52 \cdot UI$	-	-	ns
$T_{CLK-TRAIL}$	Time that the transmitter drives the flipped differential state after last payload data bit of a HS transmission burst.	60	-	-	ns
$T_{CLK-PREPARE}$	Time that the HS clock shall be driven by the transmitter prior to any associated Data Lane beginning the transition from LP to HS mode.	38	-	95	ns
$T_{CLK-PREPARE} + T_{CLK-ZERO}$	TCLK-PREPARE + time that the transmitter drives the HS-0 state prior to starting the Clock.	300	-	-	ns
$T_{CLK-PRE}$	Time that the HS clock shall be driven by the transmitter prior to any associated Data Lane beginning the transition from LP to HS mode.	$8 \cdot UI$	-	-	ns

4. Optical Specifications

Item	Symbol	Condition	Values			Unit	Remark
			Min.	Typ.	Max.		
Viewing angle (CR $\geq$ 10)	θ_L	$\Phi=180^\circ$ (9 o'clock)	-	80	-	deg ree	Note 1
	θ_R	$\Phi=0^\circ$ (3 o'clock)	-	80	-		
	θ_T	$\Phi=90^\circ$ (12 o'clock)	-	80	-		
	θ_B	$\Phi=270^\circ$ (6 o'clock)	-	80	-		
Response time	T_{ON+} T_{OFF}	Normal $\theta=\Phi=0^\circ$	-	35	45	ms ec	Note 3
Contrast ratio	CR		1100	1500	-	-	Note 4
Color chromaticity	W_X		0.2727	0.3027	0.3327	-	Note 2 Note 5
	W_Y		0.2732	0.3032	0.3332	-	Note 6
Luminance	L		800	900	-	cd/ m ²	Note 6
Luminance uniformity	Y_U		70	80	-	%	Note 7
Color Gamut	NTSC	CIE1931	60	70	-	%	

The test systems refer to Note 2.

Note 1: Definition of viewing angle range

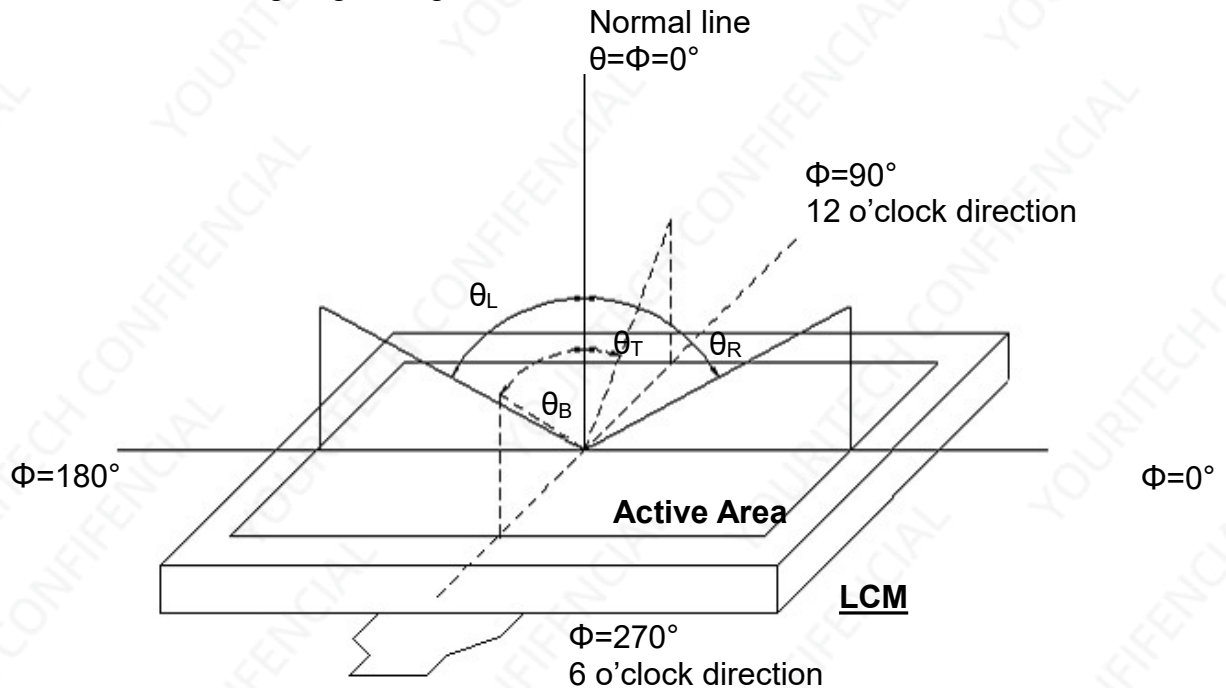


Fig. 4-1 Definition of viewing angle

Note 2: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 30 minutes operation, the optical properties are measured at the center point of the LCD screen. (Viewing angle is measured by ELDIM-EZ contrast/Height :1.2mm, Response time is measured by Photo detector TOPCON BM-7, other items are measured by BM-5A/ Field of view: 1° /Height: 500mm.) or CA-210.

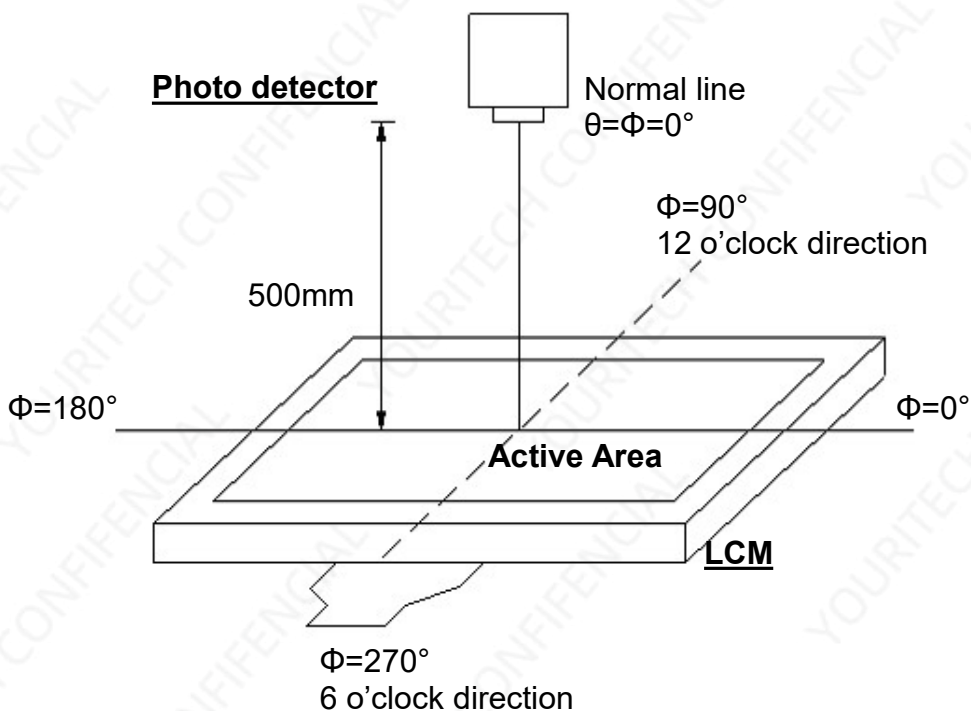


Fig. 4-2 Optical measurement system setup

Note 3: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.

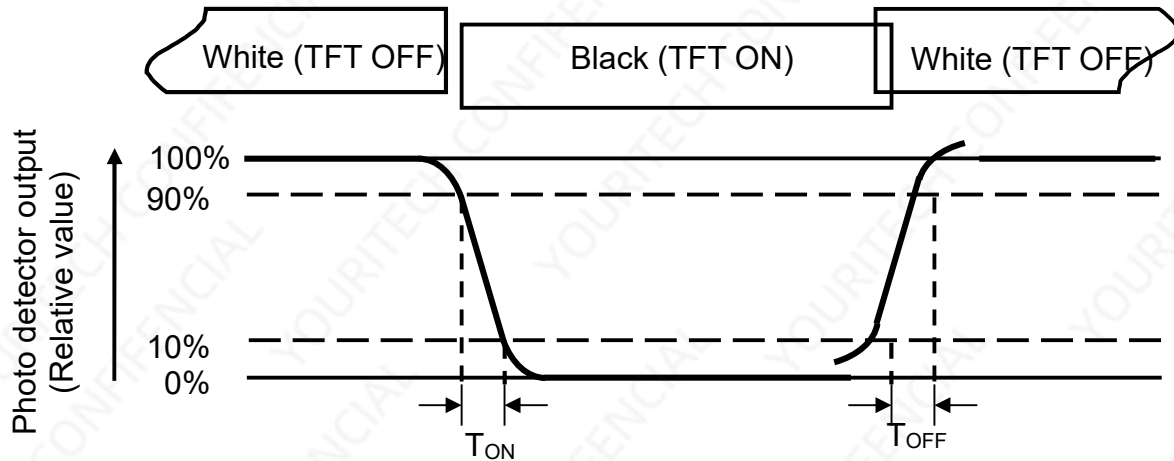


Fig. 4- 3 Definition of response time

Note 4: Definition of contrast ratio

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: All input terminals LCD panel must be ground while measuring the center area of the panel. The LED driving condition is $I_L=120\text{mA}$.

Note 7: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas(Refer to Fig. 4-4).
Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity (Yu)} = \frac{B_{\min}}{B_{\max}}$$

L-----Active area length

W----- Active area width

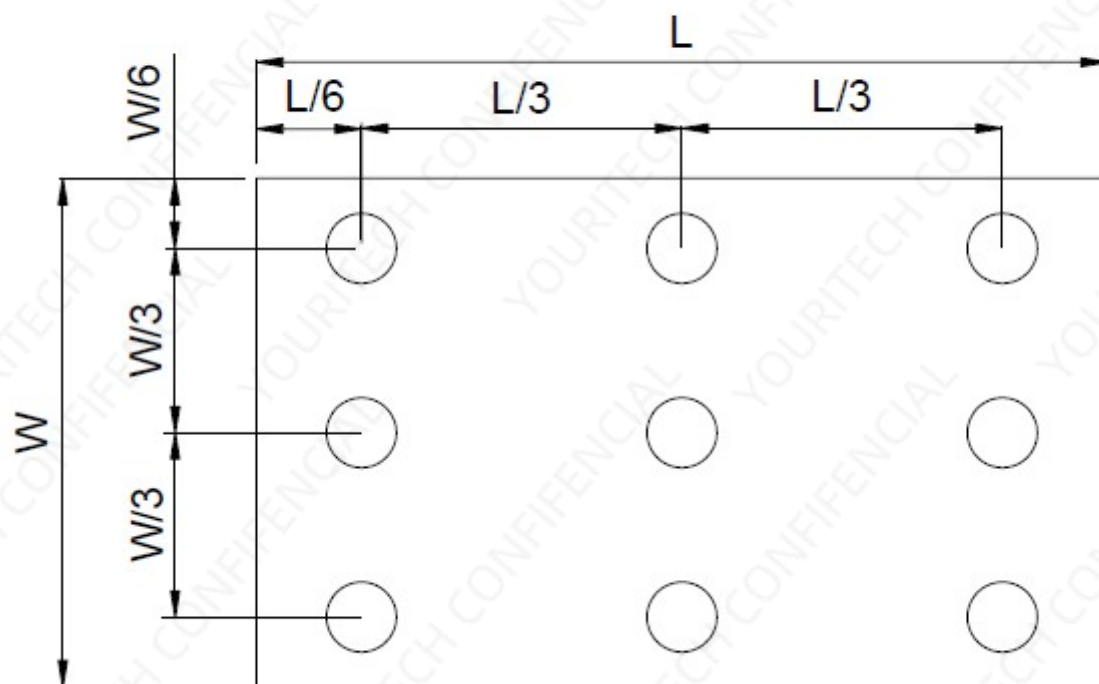


Fig. 4-4 Definition of measuring points

$B_{\max}$: The measured maximum luminance of all measurement position.

$B_{\min}$: The measured minimum luminance of all measurement position.

5. Reliability Test

Item	Test Conditions	Criterion
High Temperature Storage	Ta = 80℃ 240hrs	A,B,C,D,E
Low Temperature Storage	Ta = -30℃ 240hrs	A,B,C,D,E
High Temperature Operation	Ts = 70℃ 240hrs	A,B,C,D,E
Low Temperature Operation	Ta = -20℃ 240hrs	A,B,C,D,E
Operate at High Temperature and Humidity	+60℃, 90%RH 240hrs	A,B,C,D,E
Thermal Shock(non operation)	-30℃/30 min ~ +80℃/30 min for a total 24 cycles, Start with cold temperature and end with high temperature.	A,B,C,D,E
Vibration Test	Sweep:10Hz~55Hz~10Hz 2G 2 hours for each direction of X. Y. Z. (6 hours for total)	A,B,C,D,E
Package Vibration Test	Random Vibration : 0.015G*G/Hz from 5-200HZ, -6dB/Octave from 200-500HZ 2 hours for each direction of X. Y. Z. (6 hours for total)	A,B,C,D,E
Package Drop Test	Height:60 cm 1 corner, 3 edges, 6 surfaces	A,B,C,D,E
Electro Static Discharge	Contact=+/-4KV, Air=+/-8KV,(R=330R,C=150pF), 1 sec,9point,10times/point;	A,B,C,D,E

※Criterion:

A.LCM each function is OK,.

B.LCM appearance inspection without abnormalities (Including scratch, damage, corrosion and serious deformation)

C.LCM brightness above the Min. value of Spec.

D. Luminance uniformity above the Min. value of Spec.

E. Color chromaticity within tolerance range

7. Package Drawing

TBD

8. General Precautions

8.1. Safety

Liquid crystal is poisonous. Do not put it in your mouth. If liquid crystal touches your skin or clothes, wash it off immediately by using soap and water.

8.2. Handling

1. The LCD panel is plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.
2. The polarizer attached to the display is easily damaged. Please handle it carefully to avoid scratch or other damages.
3. To avoid contamination on the display surface, do not touch the module surface with bare hands.
4. Keep a space so that the LCD panels do not touch other components.
5. Put cover board such as acrylic board on the surface of LCD panel to protect panel from damages.
6. Transparent electrodes may be disconnected if you use the LCD panel under environmental conditions where the condensation of dew occurs.
7. Do not leave module in direct sunlight to avoid malfunction of the ICs.

8.3. Static Electricity

1. Be sure to ground module before turning on power or operating module.
2. Do not apply voltage which exceeds the absolute maximum rating value.

8.4. Storage

1. Store the module in a dark room where must keep at $25\pm 10^{\circ}\text{C}$ and 65%RH or less.
2. Do not store the module in surroundings containing organic solvent or corrosive gas.
3. Store the module in an anti-electrostatic container or bag.

8.5. Cleaning

1. Do not wipe the polarizer with dry cloth. It might cause scratch.
2. Only use a soft sloth with IPA to wipe the polarizer, other chemicals might permanent damage to the polarizer.